

注記 NOTES

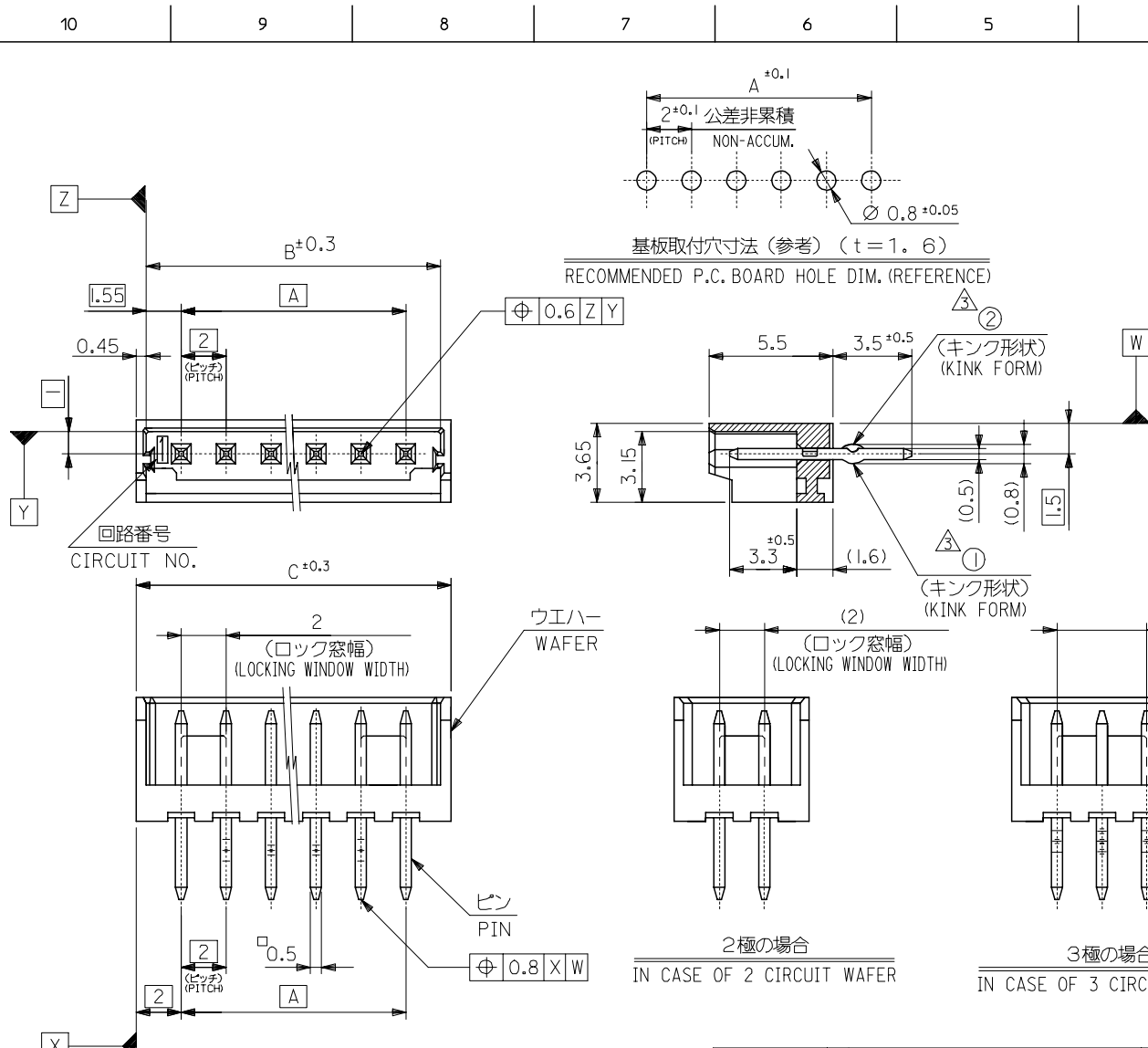
1. 嵌合相手: 51065 シリーズ
MATE WITH: 51065 SERIES
2. 材質 MATERIAL
ウエハー: 66ナイロン, UL94V-0
WAFER: 66NYLON, UL94V-0
ピン: 黄銅, 金メッキ
PIN: BRASS, GOLD (Au) PLATING

△ キングは下記表の位置及び形状に付加のこと。2極はキング無し。
KINK TO BE APPLIED AS FOLLOWS,
2 CIRCUIT HAS NO KINK.

極数 CKT	回路番号 CKT NO.	回路番号							
		1	2	3	4	5	N-2	N-1	N
6 極以上	MORE THAN 6 CKT	—	①	②	—	—	②	①	—
5 極	5 CKT	①	②	—	②	①			
4 極	4 CKT	①	②	②	①				
3 極	3 CKT	①	②	①					

4. 本製品は、53253-**70の金メッキ品です。
THIS PRODUCT IS AU PLATING OF 53253-**70.
5. 梱包仕様 PACKAGING
502603-**70 トレー TRAY
502603-**50 ポリ袋 POLYBAG

32	31.1	28	502603-1550	502603-1570	15
30	29.1	26	-1450	-1470	14
28	27.1	24	-1350	-1370	13
26	25.1	22	-1250	-1270	12
24	23.1	20	-1150	-1170	11
22	21.1	18	-1050	-1070	10
20	19.1	16	-0950	-0970	9
18	17.1	14	-0850	-0870	8
16	15.1	12	-0750	-0770	7
14	13.1	10	-0650	-0670	6
12	11.1	8	-0550	-0570	5
10	9.1	6	-0450	-0470	4
8	7.1	4	-0350	-0370	3
6	5.1	2	502603-0250	502603-0270	2
C	B	A	MATERIAL NO.	MATERIAL NO.	極数
			MODEL NO.	MODEL NO.	



基板取付穴寸法 (参考) (t=1.6)
RECOMMENDED P.C. BOARD HOLE DIM. (REFERENCE)

2極の場合
IN CASE OF 2 CIRCUIT WAFER

3極の場合
IN CASE OF 3 CIRCUIT WAFER

RELEASED EC NO: J2007-2775 DRWN: MAEDA CHK: NUKITA APPR: NUKITA 2007/04/04 2007/04/06 2007/04/06	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY YMAEDA		TITLE NEW 2.0 WIRE TO BOARD CONN. WAFER ASSY (ST.) -LEAD FREE-		
	10 OVER 30 UNDER	±0.25	DATE 2007/03/30		MOLEX INCORPORATED DOCUMENT NO. SD-502603-001 SHEET NO. 1 OF 1		
	30 OVER	±0.3	CHECKED BY KTOYOTA				
	0	ANGULAR ±3°	DATE 2007/03/30		MATERIAL NO. SEE CHART		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		APPROVED BY NUKITA		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			